

# **Radial Lead Resettable Polymer PTCs**

### SC30-700SZ0D

#### Features

- u RoHS Compliant and Halogen-Free
- u Radial leaded Devices
- Cured,flame retardant epoxy polymer insulating material meets UL94V-0 requirements
- U Operation Current: 7.00A, Maximum Voltage: 30Vdc, Operating Temperature: -40℃ to +85℃

#### **Applications**

- u USB hubs, ports and peripherals
- **u** Power ports
- u IEEE1394 ports
- **u** Motor protection
- u Automotive application
- u Computers and peripherals
- **u** General electronics

#### **Electrical Parameters**

Port Number	Number L(A) V max I max P <sub>dtyp</sub>		P <sub>dtyp</sub>	Maximu To	ım Time Trip	Resistance				
Part Number	I <sub>hold</sub> (A)	I <sub>trip</sub> (A)	(Vdc)	(A)	(W)	Current (A)	Time (S)	R <sub>min</sub> (Ω)	R <sub>max</sub> (Ω)	R1 <sub>max</sub> (Ω)
SC30-700SZ0D	7.00	14.00	30	40	3.80	35.0	17.5	0.005	0.020	0.040

I  $_{\text{hold}}\text{=}$  Hold current: maximum current at which the device will not trip at 25  $^\circ\!\!\mathbb{C}$  still air.

I  $_{trip}\text{=}$  Trip current: minimum current at which the device will always at 25  $^\circ\!\!\mathbb{C}$   $\,$  still air.

V  $_{\mbox{max}}\mbox{=}$  Maximum voltage device can withstand without damage at rated current.

I  $_{\mbox{max}}\mbox{=}$  Maximum fault current device can withstand without damage at rated voltage.

T trip=Maximum time to trip(s) at assigned current.

P<sub>dtyp</sub>= Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R  $_{\text{min}}\text{=}$  Minimum device resistance at 25  $^\circ\!\mathrm{C}$   $\,$  prior to tripping.

R  $_{\text{max}}\text{=}$  Maximum device resistance at 25  $^\circ\!\mathrm{C}$  prior to tripping.

R1<sub>max</sub>= Maximum resistance of device at 25 °C measured one hour after tripping.

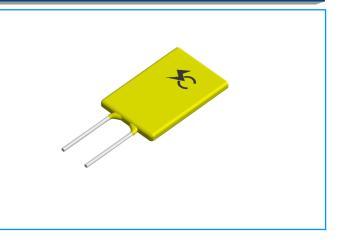
Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

## Temperature Rerating Chart - I hold (A)

Ambient Operation										
Temperature	<b>-40</b> ℃	<b>-20°</b> ℃	<b>0°</b> ℃	<b>23</b> ℃	<b>30</b> ℃	<b>40</b> ℃	<b>50</b> ℃	<b>60</b> ℃	<b>70</b> ℃	<b>85</b> ℃
Percentage Reduction	145%	130%	120%	100%	95%	88%	80%	71%	66%	56%

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Specifications are subject to change without notice. Please refer to <u>www.socay.com for current information</u>.



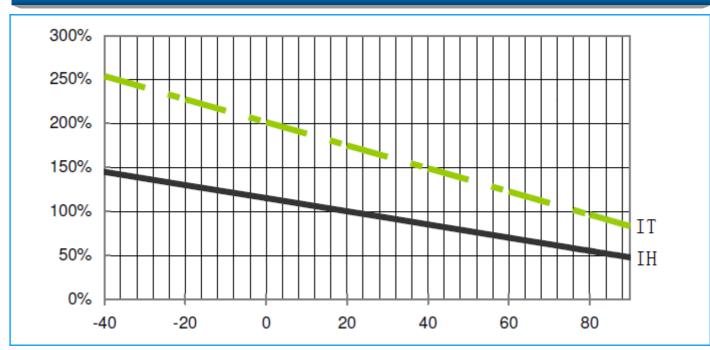


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## SC30-700SZ0D

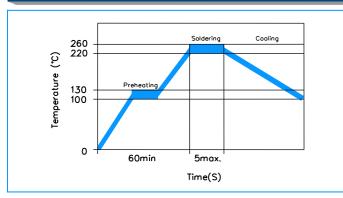
#### **Temperature Derating Curve**



#### **Test Procedures and Requirement**

Test	Test Conditions	Accept/Reject Criteria
Resistance	In still air @25±2°C	$R_{min} \leq R \leq R_{max}$
Hold Current	60 min, at I <sub>hold</sub> , In still air @25±2°C	No trip
Time to Trip	Specified current, V <sub>max</sub> , @25±2°C	T≤Maximum Time To Trip
Trip Cycle Life	V <sub>max</sub> , I <sub>max</sub> ,100 cycles	No arcing or burning
Trip Endurance	Vmax,24hours	No arcing or burning

## **Soldering Parameters**



Pre-Heating Zone	Refer to the condition recommended by the manufacturer. Max. ramping rate should not exceed 4°C/Sec
Soldering Zone	Max. solder temperature should not exceed 260°C
Cooling Zone	Cooling by natural convection in air

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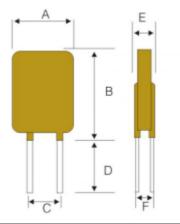
# Radial Lead Resettable Polymer PTCs

## SC30-700SZ0D

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Lead Material	0.03-1.85A Tin-plated Copper clad steel 2.50-5.00A Tin-plated Copper
Soldering Characteristics	Solder ability per MIL-STD-202, Method 208E
Insulating Material	Cured, flame retardant epoxy polymer meets UL 94V-0 requirements.
Device Labeling	Marked with 'SC', voltage, current rating

#### Dimensions



Part Number		Lead Material					
Part Number	A (Max)	B (Max)	С (Тур)	D (Min)	E (Max)	F (Тур)	Tinned Metal (mm)
SC30-700SZ0D	19.1	26.7	10.2	7.6	3.0	1.2	Φ0.80

Packaging Quantity					
Part Number	Quantity (pcs/reel)				
SC30-700SZ0D	200				